

$V_{RRM} = 1700 \text{ V}$

$I_F = 150 \text{ A}$

Fast-Diode Die

5SLX 12K1711



Die size: 11.9 x 11.9 mm

Doc. No. 5SYA1662-01 Feb. 05

- Fast and soft reverse-recovery
- Low losses
- High SOA
- Passivation: SIPOS Nitride plus Polyimide

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	max	Unit
Repetitive peak reverse voltage	V_{RRM}			1700	V
Continuous forward current	I_F			150	A
Repetitive peak forward current	I_{FRM}	Limited by T_{vjmax}		300	A
Junction temperature	T_{vj}		-40	125	°C

¹⁾ Maximum rated values indicate limits beyond which damage to the device may occur per IEC 60747 - 2

Diode characteristic values ²⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Continuous forward voltage	V _F	I _F = 150 A	T _{vj} = 25 °C	1.4	1.65	2.0 V
			T _{vj} = 125 °C		1.7	V
Continuous reverse current	I _R	V _R = 1700 V	T _{vj} = 25 °C		100	μA
			T _{vj} = 125 °C		3	mA
Peak reverse recovery current	I _{rr}	I _F = 150 A, V _R = 900 V, di/dt = 800 A/μs, L _σ = 800 nH, Inductive load, Switch: 2x 5SMX12K1701	T _{vj} = 25 °C		118	A
			T _{vj} = 125 °C		146	A
Recovered charge	Q _{rr}		T _{vj} = 25 °C		43	μC
			T _{vj} = 125 °C		73	μC
Reverse recovery time	t _{rr}		T _{vj} = 25 °C		460	ns
			T _{vj} = 125 °C		660	ns
Reverse recovery energy	E _{rec}		T _{vj} = 25 °C		32	mJ
			T _{vj} = 125 °C		53	mJ

²⁾ Characteristic values according to IEC 60747 - 2

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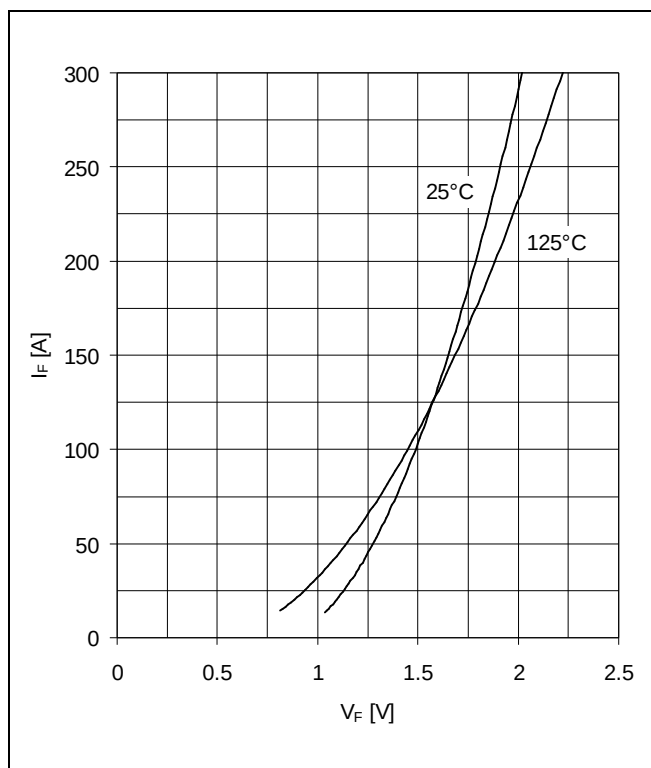


Fig. 1 Typical diode forward characteristics

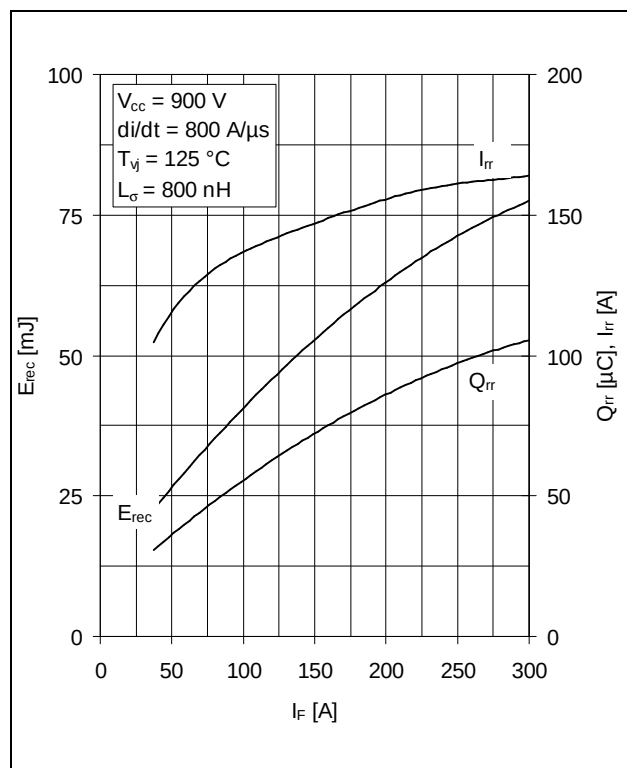


Fig. 2 Typical reverse recovery characteristics vs. forward current

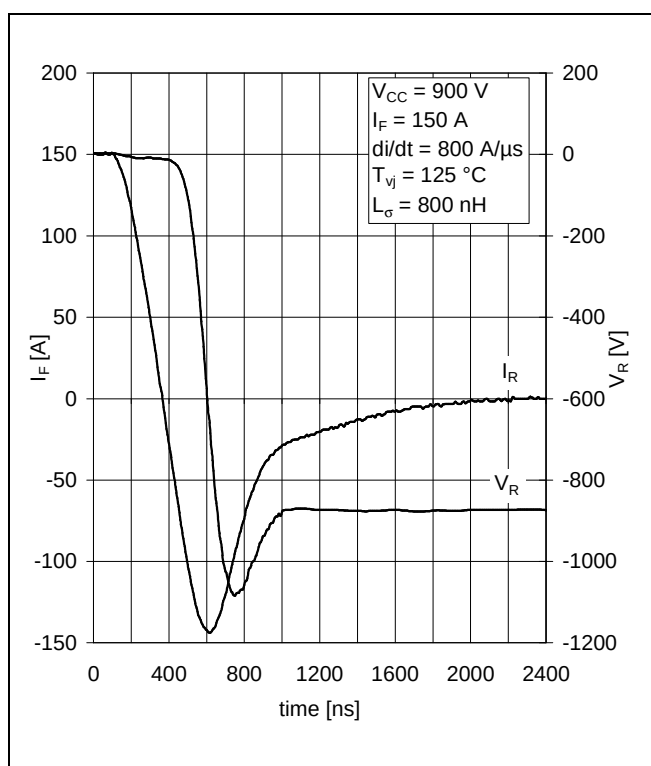


Fig. 3 Typical diode reverse recovery behaviour

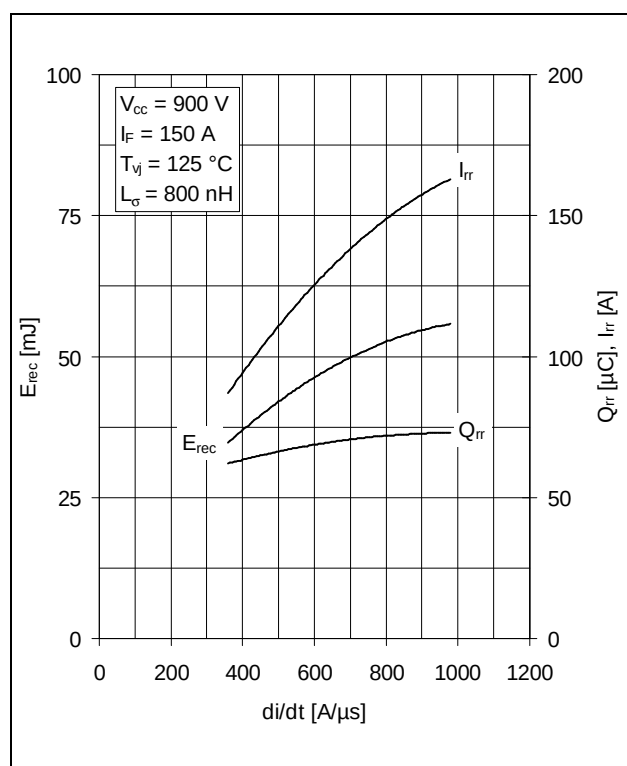


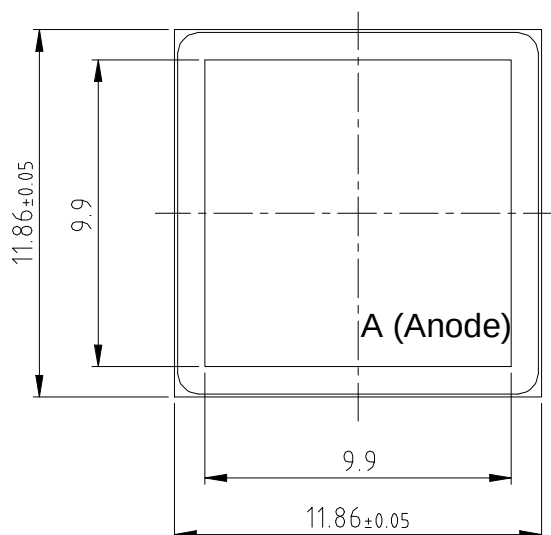
Fig. 4 Typical reverse recovery vs. di/dt

Mechanical properties

Parameter				Unit
Dimensions	Overall die	L x W	11.9 x 11.9	mm
	exposed front metal	L x W	9.9 x 9.9	mm
	thickness		385 ± 15	µm
Metallization ³⁾	front (A)	AlSi1	4	µm
	back (K)	Al / Ti / Ni / Ag	1.2	µm

³⁾ For assembly instructions refer to: IGBT and Diode chips from ABB Switzerland Ltd, Semiconductors, Doc. No. 5SYA 2033.

Outline Drawing



Note : All dimensions are shown in mm

This product has been designed and qualified for Industrial Level.

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